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Global Semiconductor Packaging Bonders and Bonding Wires Market Growth (Status and Outlook) 2026-2032

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Abstracts

The global Semiconductor Packaging Bonders and Bonding Wires market size is predicted to grow from US$ 5380 million in 2025 to US$ 7291 million in 2032; it is expected to grow at a CAGR of 4.5% from 2026 to 2032.

In the field of semiconductor packaging, bonders and bonding wires are core equipment and materials that enable the electrical connection between "chips and external circuits". Working in synergy, they directly determine the reliability, performance, and cost of electronic devices. A bonder is a high-precision automated device. Its core function is to "bond" the two ends of a bonding wire to the chip's "pads" and external packaging leads (Lead Frame) or substrates (Substrate) respectively through physical/chemical actions. This process forms a stable electrical path while achieving mechanical fixation and heat conduction. A bonding wire is an ultra-fine metal wire used to connect chips to external circuits. It serves not only as a "bridge" for electrical signal transmission but also as a channel for heat conduction. The material, diameter, and purity of bonding wires directly affect the conductivity, fatigue resistance, and reliability of the connection. Both bonders and bonding wires belong to the core supply chain of the semiconductor packaging process. They maintain a collaborative "equipment-consumable" relationship, jointly serving downstream packaging factories while relying on upstream suppliers of raw materials and core components. In 2024, global Bonder production reached approximately 10,403 units, with an average global market price of around k US$ 247.25 per unit. In 2024, global Bonding Wires production reached approximately 4,928.52 Million Meters, with an average global market price of around US$ 543.47 per Meters.

United States market for Semiconductor Packaging Bonders and Bonding Wires is

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estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

China market for Semiconductor Packaging Bonders and Bonding Wires is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

Europe market for Semiconductor Packaging Bonders and Bonding Wires is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

Global key Semiconductor Packaging Bonders and Bonding Wires players cover Besi, ASMPT Ltd, Kulicke & Soffa, Shibaura, Shinkawa Ltd., etc. In terms of revenue, the global two largest companies occupied for a share nearly % in 2025.

Report Scope

LPI (LP Information)' newest research report, the “Semiconductor Packaging Bonders and Bonding Wires Industry Forecast” looks at past sales and reviews total world Semiconductor Packaging Bonders and Bonding Wires sales in 2025, providing a comprehensive analysis by region and market sector of projected Semiconductor Packaging Bonders and Bonding Wires sales for 2026 through 2032. With Semiconductor Packaging Bonders and Bonding Wires sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US$ millions of the world Semiconductor Packaging Bonders and Bonding Wires industry.

This Insight Report provides a comprehensive analysis of the global Semiconductor Packaging Bonders and Bonding Wires landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyses the strategies of leading global companies with a focus on Semiconductor Packaging Bonders and Bonding Wires portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms’ unique position in an accelerating global Semiconductor Packaging Bonders and Bonding Wires market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Semiconductor Packaging Bonders and Bonding Wires and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on

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hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Semiconductor Packaging Bonders and Bonding Wires.

This report presents a comprehensive overview, market shares, and growth opportunities of Semiconductor Packaging Bonders and Bonding Wires market by product type, application, key players and key regions and countries.

Market Segmentation

Segmentation by Type:

Bonder

Bonding Wires

Segmentation by Application:

Integrated device manufacturer (IDMs)

Outsourced semiconductor assembly and test (OSATs)

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

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China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analyzing the company's coverage, product portfolio, its

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market penetration.

Besi

ASMPT Ltd

Kulicke & Soffa

Shibaura

Shinkawa Ltd.

Fasford Technology

SUSS MicroTec

Hanmi

Palomar Technologies

Panasonic

Toray Engineering

Ultrasonic Engineering

Hesse GmbH

SET

F&K Delvotec

WestBond, Inc.

Hybond

DIAS Automation

MK Electron

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Tanaka

Heraeus

LT Metals

Nippon Micrometal Corporation

Doublink Solders

Microblue Electronic ?Technology

Kangqiang Electronics

Kanfort

Tatsuta

Ametek Coining

Yantai YesNo Electronic Materials

Gpilot Technology

Niche-Tech

CCC Bonding Wire

World Star Electronic Material

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